

TOSHIBA LED Lamp InGaAlP Red Light Emission

TLRH262

Panel Circuit Indicator

- 3.1 mm diameter (T1)
- InGaAlP red LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity red light emission
Recommended forward current: $I_F = 1\sim 20$ mA (DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- High power luminous intensity
- Applications: Suitable for backlighting.

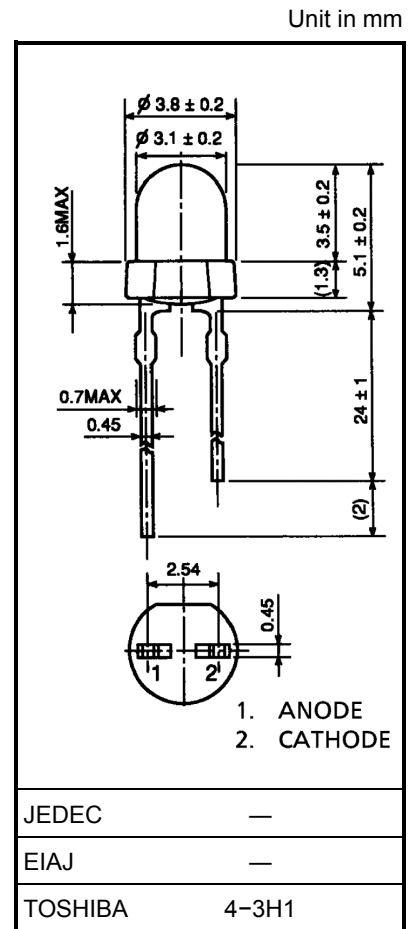
Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Forward current (DC)	I_F	50	mA
Reverse voltage	V_R	4	V
Power dissipation	P_D	125	mW
Operating temperature range	T_{opr}	-30~85	°C
Storage temperature range	T_{stg}	-40~120	°C

Electrical And Optical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Forward voltage		V_F	$I_F = 20$ mA	—	1.9	2.5	V
Reverse current		I_R	$V_R = 4$ V	—	—	50	μA
Luminous intensity	TLRH262	I_V	$I_F = 20$ mA (Note)	85	220	—	mcd
	TLRH262 (NP)			85	—	414	
Peak emission wavelength		λ_P	$I_F = 20$ mA	—	644	—	nm
Spectral line half width		$\Delta\lambda$	$I_F = 20$ mA	—	18	—	nm
Dominant wavelength		λ_d	$I_F = 20$ mA	—	630	—	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity.
 Measurement tolerance for each limit is ±15%.
 N: 100–200 mcd, P: 180–360 mcd, Q: 320–640 mcd.

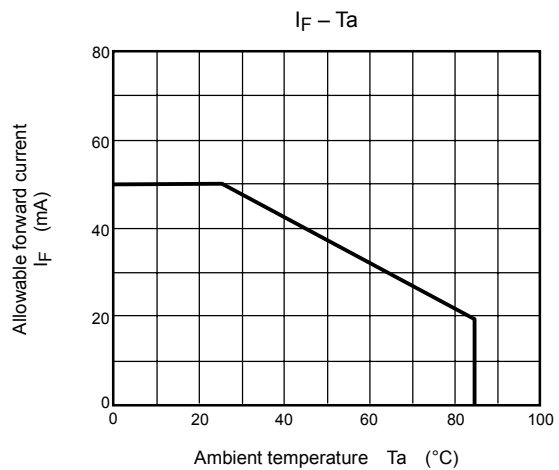
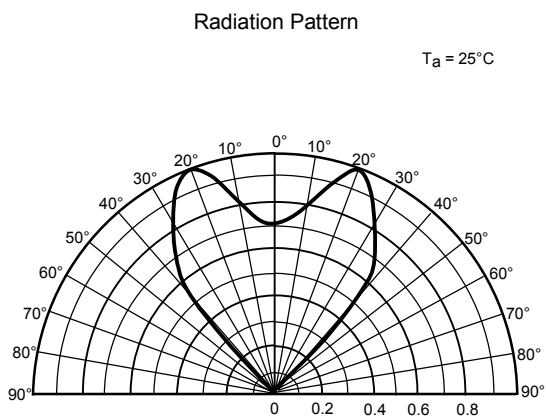
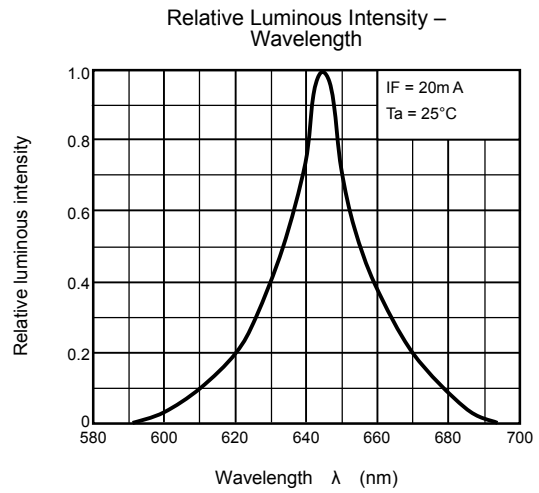
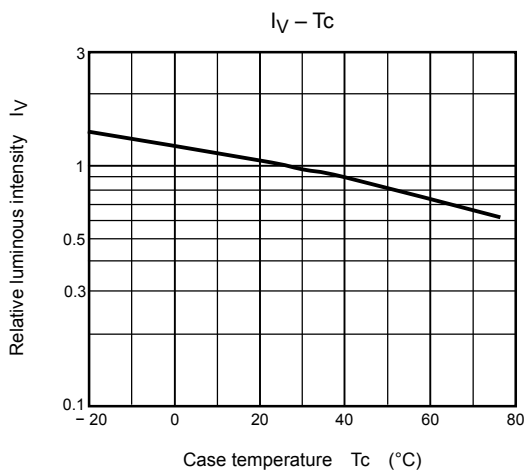
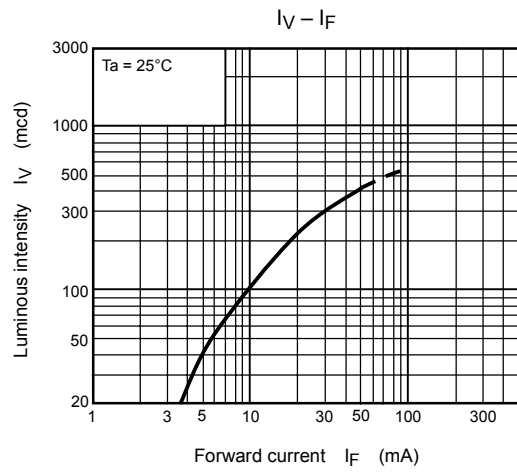
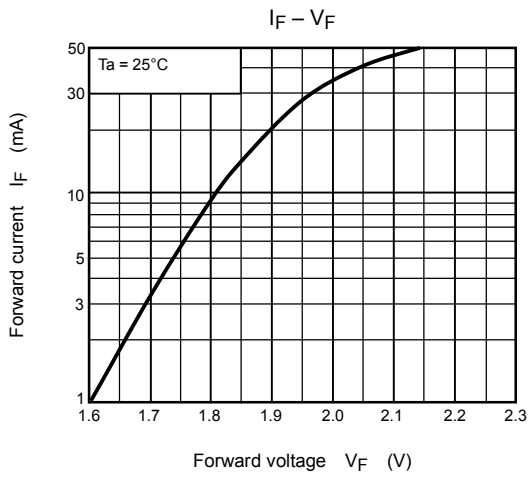


Weight: 0.14 g

Precaution

Please be careful of the followings

- Soldering temperature: 260°C max Soldering time : 3 s max
(soldering portion of lead: Up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.



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